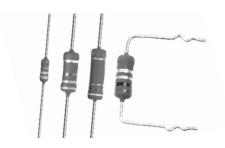


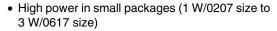
Power Metal Film Leaded Resistors



DESCRIPTION

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, non-flammable lacquer which provides electrical, mechanical and climatic protection. This coating is not resistant to aggressive fluxes. The encapsulation is resistant to all cleaning solvents in accordance with IEC 60068-2-45.

FEATURES





- Different lead materials for different applications
- · Defined interruption behaviour
- Lead (Pb)-free solder contacts
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

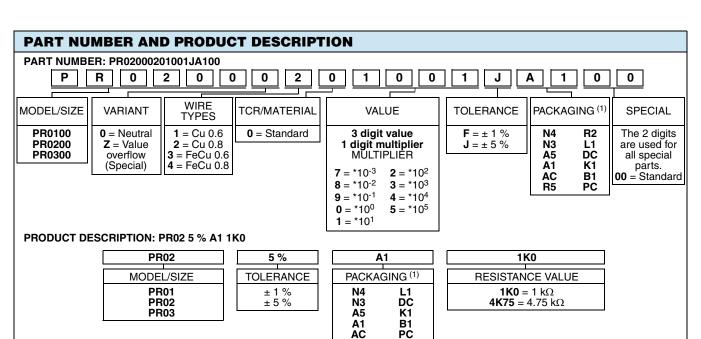
• All general purpose power applications

	VALUE							
DESCRIPTION	DD01	PR0	2	PR03				
	PR01	Cu-lead	FeCu-lead	Cu-lead	FeCu-lead			
Resistance Range (2)	0.22 Ω to 1 M Ω	0.33 Ω to 1 M Ω	1 Ω to 1 MΩ	0.68 Ω to 1 M Ω	1 Ω to 1 MΩ			
Resistance Tolerance and Series		± 1 % (E24, E9	6 series); ± 5 % (E	24 series) ⁽¹⁾				
Rated Dissipation, P ₇₀ :								
R < 1 Ω	0.6 W	1.2 W	-	1.6 W	-			
1 Ω ≤ R	1 W	2 W	1.3 W	3 W	2.5 W			
Thermal Resistance (R _{th})	135 K/W	75 K/W	115 K/W	60 K/W	75 K/W			
Temperature Coefficient			≤ ± 250 ppm/K					
Maximum Permissible Voltage (U _{max.} AC/DC)	350 V	500	V	750	V			
Basic Specifications			IEC 60115-1					
Climatic Category (IEC 60068-1)			55/155/56					
Stability After:								
Load (1000 h, <i>P</i> ₇₀)		∆R ma	ax.: ± (5 % <i>R</i> + 0.1	Ω)				
Long Term Damp Heat Test (56 Days)		∆R ma	ax.: ± (3 % <i>R</i> + 0.1	Ω)				
Soldering (10 s, 260 °C)		ΔR ma	x.: ± (1 % R + 0.05	5 Ω)				

- (1) 1 % tolerance is available for R_n -range from 1 R upwards
- (2) Ohmic values (other than resistance range) are available on request
- R value is measured with probe distance of 24 mm ± 1 mm using 4-terminal method



Power Metal Film Leaded Resistors



R5

R2

Notes

(1) Please refer to table PACKAGING for details

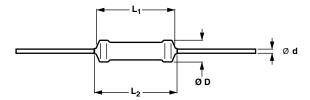
• The PART NUMBER is shown to facilitate the introduction of a unified part numbering system for ordering products

PACKAGING										
MODEL	TAPING	AMMO PACK		RE	REEL		BULK, DOUBLE KINK			
MODEL	IAPING	PIECES	CODE	PIECES	CODE	PITCH	PIECES	CODE		
	Avial F0 mm	5000	A5	5000	R5					
PR01	Axial, 52 mm	1000	A1							
PHUI	Radial	4000	N4			17.8 mm	1000	L1		
	Haulai					12.5 mm	1000	K1		
	Axial, 52 mm	1000	A1	5000	R5					
PR02	Dadial	3000	N3	2000	R2	17.8 mm	1000	L1		
	Radial					15.0 mm	1000	B1		
	Axial, 63 mm	500	AC							
PR03	Radial					25.4 mm	500	DC		
	naulai					20.0 mm	500	PC		

Power Metal Film Leaded Resistors

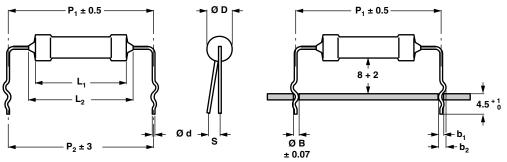


DIMENSIONS



Type with straight leads

DIMENSIONS - Straight lead type and relevant physical dimensions; see straight leads outline									
TYPE	Ø D _{max} . L _{1 max} . L _{2 max} .			d m)					
	(mm)	(mm)	(mm)	Cu	FeCu				
PR01	2.5	6.5	8.0	0.58 ± 0.05	-				
PR02	3.9	10.0	12.0	0.78 ± 0.05	0.58 ± 0.05				
PR03	5.2	16.7	19.5	0.78 ± 0.05	0.58 ± 0.05				



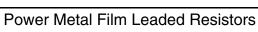
Type with double kink

Dimensions in millimeters

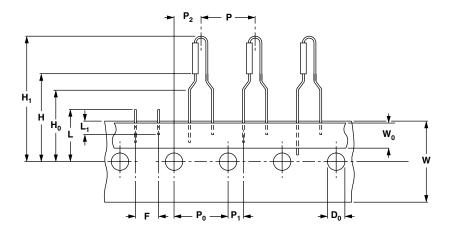
DIME	DIMENSIONS - Double kink lead type and relevant physical dimensions; see double kinked outline											
TYPE	LEAD STYLE	Ø d (mm)		b ₁	b ₂	Ø D _{max} .	P ₁	P ₂	S _{max} .	Ø B		
		Cu	FeCu	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)		
PR01	Double kink large pitch	0.58 ± 0.05	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.45 + 0.25/- 0.20	2.5	17.8	17.8	2	8.0		
Fhui	Double kink small pitch	-	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.45 + 0.25/- 0.20	2.5	12.5	12.5	2	0.8		
PR02	Double kink large pitch	0.78 ± 0.05	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.45 + 0.25/- 0.20	2.0	17.8	17.8	2	0.8		
FHU2	Double kink small pitch		3.9	15.0	15.0	2	1.0					
PR03	Double kink large pitch	0.78 ± 0.05	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.65 + 0.25/- 0.20	5.2	25.4	25.4	2	1.0		
FHUS	Double kink small pitch	-	0.78 ± 0.05	1.30 + 0.25/- 0.20	2.15 + 0.25/- 0.20	3.2	22.0	20.0	2	1.0		

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PRODUCTS WITH RADIAL LEADS (PR01, PR02)



DIMENSIONS - RADIAL TAPING									
SYMBOL	PARAMETER	VALUE	TOLERANCE	UNIT					
Р	Pitch of components	12.7	± 1.0	mm					
P ₀	Feed-hole pitch	12.7	± 0.2	mm					
P ₁	Feed-hole centre to lead at topside at the tape	3.85	± 0.5	mm					
P ₂	Feed-hole center to body center	6.35	± 1.0	mm					
F	Lead-to-lead distance	4.8	+ 0.7/- 0	mm					
W	Tape width	18.0	± 0.5	mm					
W ₀	Minimum hold down tape width	5.5	-	mm					
П	Component height PR01	29	Max.	mm					
H ₁	Component height PR02	29	± 3.0	mm					
H ₀	Lead wire clinch height	16.5	± 0.5	mm					
Н	Height of component from tape center	19.5	± 1	mm					
D ₀	Feed-hole diameter	4.0	± 0.2	mm					
L	Maximum length of snipped lead	11.0	-	mm					
L ₁	Minimum lead wire (tape portion) shortest lead	2.5	-	mm					

Note

• Please refer document number 28721 "Packaging" for more detail

Power Metal Film Leaded Resistors



MASS PER UNIT						
TYPE	MASS (mg)					
PR01 Cu 0.6 mm	212					
PR01 FeCu 0.6 mm	207					
PR02 Cu 0.8 mm	504					
PR02 FeCu 0.6 mm	455					
PR02 FeCu 0.8 mm	496					
PR03 Cu 0.8 mm	1192					
PR03 FeCu 0.6 mm	1079					
PR03 FeCu 0.8 mm	1185					

MARKING

The nominal resistance and tolerance are marked on the resistor using four or five colored bands in accordance with IEC 60062, marking codes for resistors and capacitors.

OUTLINES

The length of the body (L₁) is measured by inserting the leads into holes of two identical gauge plates and moving these plates parallel to each other until the resistor body is clamped without deformation (IEC 60294).

MOUNTING

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines.

MOUNTING PITCH									
TYPE	LEAD STYLE	PIT	СН						
ITPE	LEAD STILE	mm	е						
	Straight leads	12.5 ⁽¹⁾	5 ⁽¹⁾						
PR01	Radial taped	4.8	2						
Phui	Double kink large pitch	17.8	7						
	Double kink small pitch	12.5	5						
	Straight leads	15.0 ⁽¹⁾	6 ⁽¹⁾						
PR02	Radial taped	4.8	2						
FN02	Double kink large pitch	17.8	7						
	Double kink small pitch	15.0	6						
	Straight leads	23.0 (1)	9 (1)						
PR03	Double kink large pitch	25.4	10						
	Double kink small pitch	20.0	8						

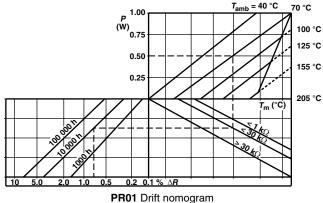
Note

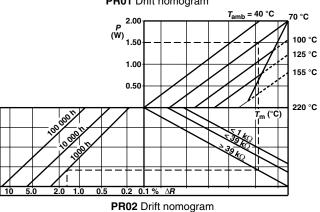
(1) Recommended minimum value

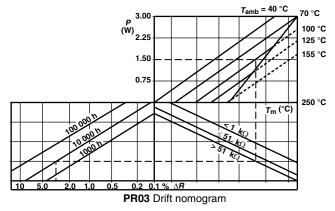
FUNCTIONAL DESCRIPTION PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E96/E24 series for resistors with a tolerance of \pm 1 % or \pm 5 %. The values of the E96/E24 series are in accordance with IEC 60063.

FUNCTIONAL PERFORMANCE





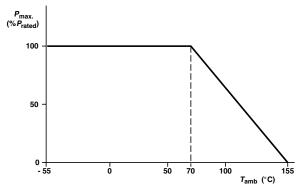


Note

 The maximum permissible hot-spot temperature is 205 °C for PR01, 220 °C for PR02 and 250 °C for PR03

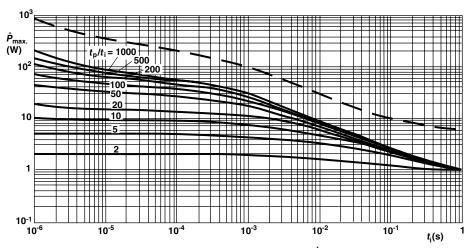
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The power that the resistor can dissipate depends on the operating temperature.

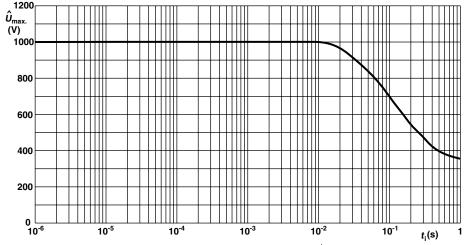


Maximum dissipation ($P_{\text{max.}}$) in percentage of rated power as a function of the ambient temperature (T_{amb})

Derating



PR01 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max.}$) as a function of pulse duration (t_i)



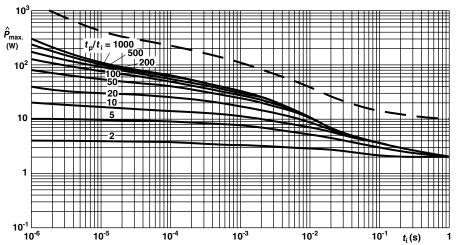
PR01 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)

Pulse Loading Capabilities

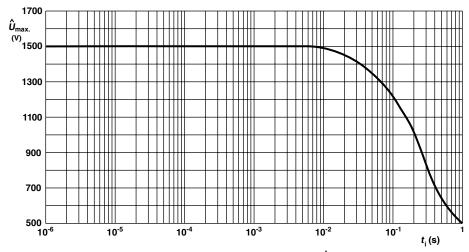
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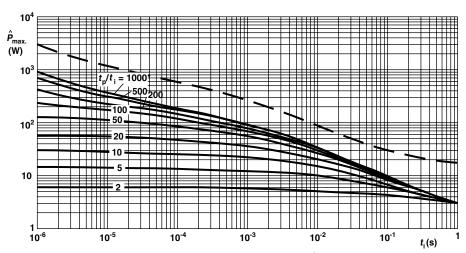




PR02 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max.}$) as a function of pulse duration (t_i)



PR02 Pulse on a regular basis; maximum permissible peak pulse voltage $(\hat{U}_{max.})$ as a function of pulse duration (t_i)



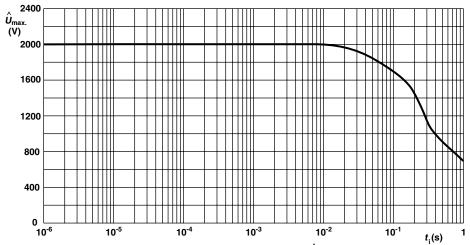
PR03 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

Pulse Loading Capabilities



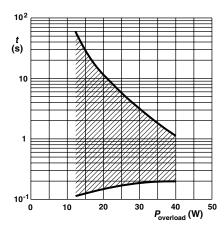
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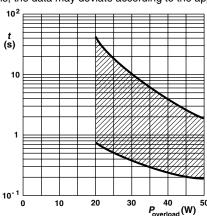
PR03 Pulse on a regular basis; maximum permissible peak pulse voltage $(\hat{U}_{max.})$ as a function of pulse duration (t_i)

Pulse Loading Capabilities



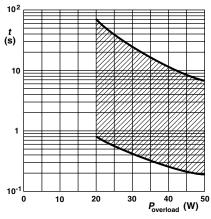
PR01 Time to interruption as a function of overload power for range: $0 R 22 \le R_n < 1 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



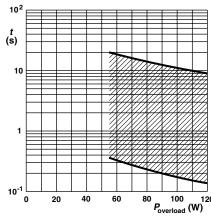
PR01 Time to interruption as a function of overload power for range: 1 $R \le R_n \le 15$ R

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR01 Time to interruption as a function of overload power for range: 16 $R \le R_n \le 560 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



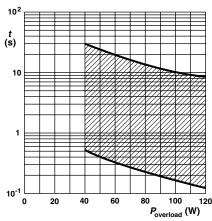
PR02 Time to interruption as a function of overload power for range: $0.33 R \le R_n < 5 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

Interruption Characteristics

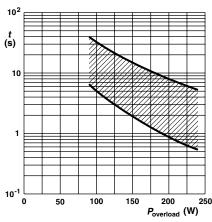
Power Metal Film Leaded Resistors





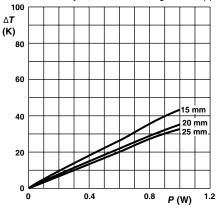
PR02 Time to interruption as a function of overload power for range: $5 R \le R_n < 68 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR03 Time to interruption as a function of overload power for range: 0.68 $R \le R_n \le 560 \ R$

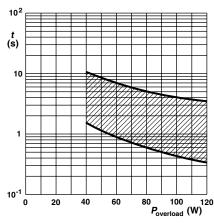
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



Ø 0.6 mm Cu-leads

Minimum distance from resistor body to PCB = 1 mm

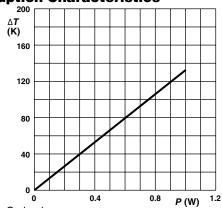
PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



PR02 Time to interruption as a function of overload power for range: $68 R \le R_n \le 560 R$

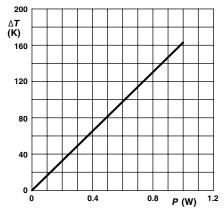
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

Interruption Characteristics



Ø 0.6 mm Cu-leads

PR01 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads

PR01 Hot-spot temperature rise (ΔT) as a function of dissipated power.

Application Information

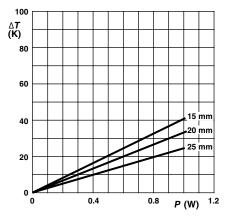
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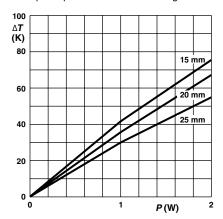
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Ø 0.6 mm FeCu-leads

Minimum distance from resistor body to PCB = 1 mm

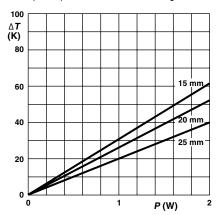
PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.8 mm Cu-leads

Minimum distance from resistor body to PCB = 1 mm

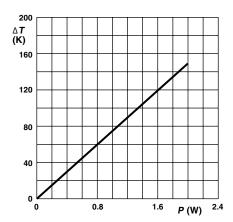
PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.6 mm FeCu-leads

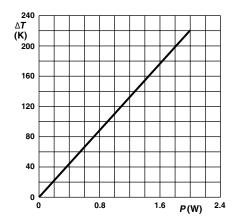
Minimum distance from resistor body to PCB = 1 mm

PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



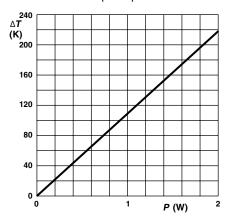
Ø 0.8 mm Cu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



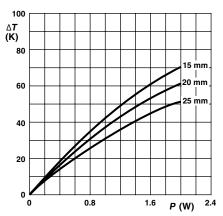
Ø 0.8 mm FeCu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.

Application Information

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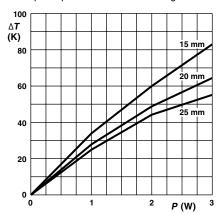




Ø 0.8 mm FeCu-leads

Minimum distance from resistor body to PCB = 1 mm

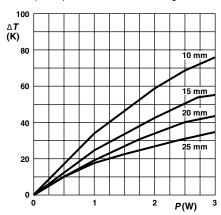
PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.8 mm Cu-leads

Minimum distance from resistor body to PCB = 1 mm

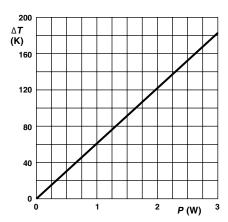
PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.6 mm FeCu-leads

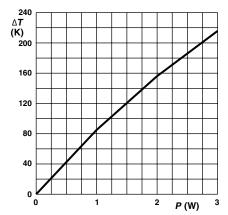
Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



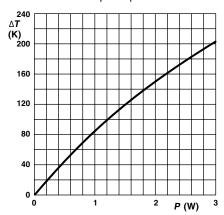
Ø 0.8 mm Cu-leads

PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads

PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.8 mm FeCu-leads

PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.

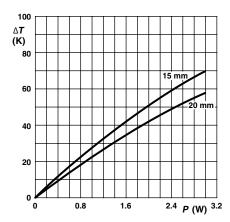
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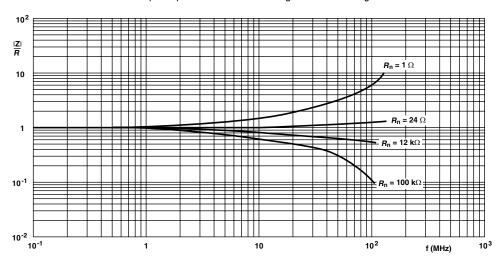
Document Number: 28729

Revision: 14-Oct-09

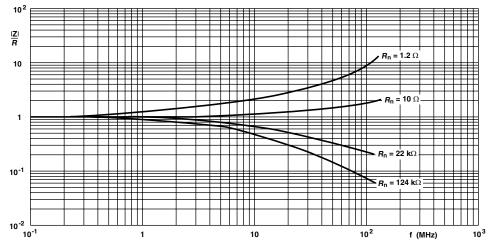


Ø 0.8 mm FeCu-leads
Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



PR01 Impedance as a function of applied frequency

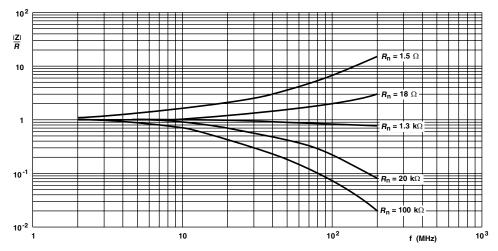


PR02 Impedance as a function of applied frequency

Application Information

Power Metal Film Leaded Resistors





PR03 Impedance as a function of applied frequency

Application Information

TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with IEC 60115-1 specification, category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days).

The tests are carried out in accordance with IEC 60068-2-xx Test Method under standard atmospheric conditions according to IEC 60068-1, 5.3.

In the Test Procedures and Requirements table, tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

TEST P	TEST PROCEDURES AND REQUIREMENTS									
IEC 60115-1 CLAUSE	IEC 60068-2- TEST METHOD	TEST	PROCEDURE	REQUIREMENTS						
4.4.1		Visual examination		No holes; clean surface; no damage						
4.4.2		Dimensions (outline)	Gauge (mm)	See Straight and Kinked Dimensions tables						
4.5		Resistance (refer note on first page for measuring distance)	Applied voltage (+ 0 %/- 10 %): $R < 10 \Omega: 0.1 \text{ V}$ $10 \Omega \le R < 100 \Omega: 0.3 \text{ V}$ $100 \Omega \le R < 1 \text{ k}\Omega: 1 \text{ V}$ $1 \text{ k}\Omega \le R < 10 \text{ k}\Omega: 3 \text{ V}$ $10 \text{ k}\Omega \le R < 100 \text{ k}\Omega: 10 \text{ V}$ $100 \text{ k}\Omega \le R < 100 \text{ k}\Omega: 25 \text{ V}$ $R = 1 \text{ M}\Omega: 50 \text{ V}$	<i>R</i> - <i>R</i> _{nom} : max. ± 5 %						
4.18	20 (Tb)	Resistance to soldering heat	Thermal shock: 10 s; 260 °C; 3 mm from body	ΔR max.: ± (1 % R + 0.05 Ω)						
4.29	45 (Xa)	Component solvent resistance	Isopropyl alcohol or H ₂ O followed by brushing	No visual damage						

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TEST PROCEDURES AND REQUIREMENTS									
IEC 60115-1 CLAUSE	IEC 60068-2- TEST METHOD	TEST	PROCEDURE	REQUIREMENTS					
4.17	20 (Ta)	Solderability	2 s; 235 °C; Solder bath method; SnPb40 3 s; 245 °C; Solder bath method; SnAg3Cu0.5	Good tinning (≥ 95 % covered); no damage					
		Solderability (after ageing)	8 h steam or 16 h 155 °C; leads immersed 6 mm: for 2 s at 235 °C; solder bath (SnPb40) for 3 s at 245 °C; solder bath (SnAg3Cu0.5)	Good tinning (≥ 95 % covered); no damage					
4.7		Voltage proof on insulation	Maximum voltage <i>U</i> _{RMS} = 500 V during 1 min; metal block method	No breakdown or flashover					
4.16		Robustness of terminations:							
4.16.2	21 (Ua1)	Tensile all samples	Load 10 N; 10 s	Number of failures: < 1 x 10 ⁻⁶					
4.16.3	21 (Ub)	Bending half number of samples	Load 5 N; 4 x 90°	Number of failures: < 1 x 10 ⁻⁶					
4.16.4	21 (Uc)	Torsion other half of samples	3 x 360° in opposite directions	No damage ΔR max.: \pm (0.5 % R + 0.05 Ω)					
4.20	29 (Eb)	Bump	3 x 1500 bumps in three directions; 40 g	No damage ΔR max.: \pm (0.5 % R + 0.05 Ω)					
4.22	6 (Fc)	Vibration	Frequency 10 Hz to 500 Hz; displacement 1.5 mm or acceleration 10 g; three directions; total 6 h (3 x 2 h)	No damage ΔR max.: \pm (0.5 % R + 0.05 Ω)					
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; 5 cycles	No visual damage PR01 : ΔR max.: \pm (1 % R + 0.05 Ω) PR02 : ΔR max.: \pm (1 % R + 0.05 Ω) PR03 : ΔR max.: \pm (2 % R + 0.05 Ω)					
4.23		Climatic sequence:							
4.23.2	2 (Ba)	Dry heat	16 h; 155 °C						
4.23.3	30 (Db)	Damp heat (accelerated) 1 st cycle	24 h; 55 °C; 90 % to 100 % RH						
4.23.4	1 (Aa)	Cold	2 h; - 55 °C						
4.23.5	13 (M)	Low air pressure	2 h; 8.5 kPa; 15 °C to 35 °C						
4.23.6	30 (Db)	Damp heat (accelerated) remaining cycles	5 days; 55 °C; 95 % to 100 % RH	$R_{\rm ins}$ min.: 10^3 M Ω ΔR max.: \pm (1.5 % R + 0.1 Ω)					
4.24	78 (Cab)	Damp heat (steady state)	56 days; 40 °C; 90 % to 95 % RH; loaded with 0.01 <i>P</i> ₇₀ (Steps: 0 V to 100 V)	$R_{\rm ins}$ min.: 1000 M Ω ΔR max.: \pm (3 % R + 0.1 Ω)					
4.25.1		Endurance (at 70 °C)	1000 h; loaded with <i>P</i> ₇₀ or <i>U</i> _{max} .; 1.5 h ON and 0.5 h OFF	$\Delta R \text{ max.: } \pm (5 \% R + 0.1 \Omega)$					
4.8		Temperature coefficient	Between - 55 °C and + 155 °C	≤ ± 250 ppm/K					
4.6.1.1		Insulation resistance	Maximum voltage (DC) after 1 min; metal block method	R_{ins} min.: 10 4 M Ω					

Power Metal Film Leaded Resistors



12NC INFORMATION FOR HISTORICAL CODING REFERENCE

The resistors have a 12-digit numeric code starting with 23 For 5 % tolerance:

- The next 7 digits indicate the resistor type and packing
- The remaining 3 digits indicate the resistance value:
 - The first 2 digits indicate the resistance value
 - The last digit indicates the resistance decade

For 1 % tolerance:

- The next 6 digits indicate the resistor type and packing
- The remaining 4 digits indicate the resistance value:
 - The first 3 digits indicate the resistance value
 - The last digit indicates the resistance decade

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.22 to 0.91 Ω	7
1 to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
1 to 9.76 kΩ	2
10 to 97.6 kΩ	3
100 to 976 kΩ	4
1 ΜΩ	5

12NC Example

The 12NC for resistor type PR02 with Cu leads and a value of 750 Ω with 5 % tolerance, supplied on a bandolier of 1000 units in ammopack, is: 2306 198 53751.

12NC	12NC - Resistor Type and Packaging (1)										
					AMMOPACK			1	REEL		
TYPE	LEAD Ø mm	TOL (%)	DADIAL	TAPED		STRAIGH	IT LEADS		DADIAL TARER		
		(/0)	KADIAL	IAPED	52 mm	52 mm	63 mm	52 mm	RADIAL TAPED		
			4000 units	3000 units	5000 units	1000 units	500 units	5000 units	2000 units		
DD01	Cu 0.6	1	=	-	22 196 1	06 191 2	-	06 191 5	=		
PR01	Cu 0.6	Cu 0.0	5	06 197 03	-	22 193 14	06 197 53	-	06 197 23	=	
	Cu 0.8	1	-	22 197 2	-	22 197 1	-	06 192 5	2322 197 5		
PR02		Cu 0.6	5	-	06 198 03	-	06 198 53	-	06 198 23	2322 198 04	
	FeCu 0.6	5	-	-	-	22 194 54	-	-	-		
	C., O.O.	5	-	-	-	-	22 195 14	-	-		
PR03 Cu 0.	Cu 0.8	1	-	-	-	-	06 199 6	-	-		
	FeCu 0.6	5	-	-	-	-	22 195 54	-	-		

Notes

[·] Preferred types in bold

12NC	12NC - Resistor Type and Packaging										
				23 (LOOS	SE IN BOX)						
TYPE	LEAD Ø	TOL		DOUBLE F	KINK						
ITPE	mm	(%)	PITCH = 17.8 mm	PITCH = 25.4 mm	PITCH (2)(3)(4)					
				1000 units	500 units	1000 units	500 units				
PR01	Cu 0.6	5	22 193 03	=	-	-					
FNUI	FeCu 0.6	5	22 193 43	-	22 193 53 ⁽²⁾	-					
	Cu 0.8	5	22 194 23	=	-	-					
PR02	FeCu 0.6	5	22 194 83	=	-	-					
	FeCu 0.8	5	-	-	22 194 63 ⁽³⁾	-					
	Cu 0.8	5	=	22 195 23	-	-					
PR03	FeCu 0.6	5	-	22 195 83	-	-					
	FeCu 0.8	5	-	-	-	22 195 63 ⁽⁴⁾					

Notes

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Document Number: 28729

Revision: 14-Oct-09

⁽¹⁾ Other packaging versions are available on request

⁽²⁾ PR01 pitch 12.5 mm

⁽³⁾ PR02 pitch 15.0 mm

⁽⁴⁾ PR03 pitch 20.0 mm, with reversed kinking direction as opposed to the drawing for the type with double kink figure

Preferred types in bold



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